

C2D05120E-Silicon Carbide Schottky Diode

Z-RECTM RECTIFIER

 $\mathbf{V}_{\mathsf{RRM}} = 1200 \ \mathsf{V}$

 $I_{c} = 5 A$

 $\mathbf{Q}_{c} = 28 \text{ nC}$

Features

- 1200-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

PIN 1 O O CASE PIN 2 O-

Package

TO-252-2

Applications

- Switch Mode Power Supplies
- Power Factor Correction
- **Motor Drives**
- High Voltage Multipliers

art Number	Package	Marking
C2D05120E	TO-252-2	C2D05120
	C2D05120E	C2D05120E TO-252-2

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V _{RRM}	Repetitive Peak Reverse Voltage	1200	V		
V _{RSM}	Surge Peak Reverse Voltage	1200	V		
V _{DC}	DC Blocking Voltage	1200	V		
$I_{\text{F(AVG)}}$	Average Forward Current	5 10	А	T _c =160°C, DC T _c =125°C, DC	
$\mathbf{I}_{\text{F(Peak)}}$	Peak Forward Current	15	А	T _c =125°C, T _{REP} <1 mS, Duty=0.5	
$\boldsymbol{I}_{\text{FRM}}$	Repetitive Peak Forward Surge Current	30	А	$T_c=25$ °C, $t_p=10$ ms, Half Sine Wave	
I _{FSM}	Non-Repetitive Peak Forward Surge Current	100	А	T _c =25°C, t _p =10 μs, Pulse	
P _{tot}	Power Dissipation	136 45	W	T _c =25°C T _c =125°C	
T _J , T _{stg}	Operating Junction and Storage Temperature	-55 to +175	°C		



Electrical Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.6 2.6	1.8 3.0	V	$I_F = 5 \text{ A } T_J = 25^{\circ}\text{C}$ $I_F = 5 \text{ A } T_J = 175^{\circ}\text{C}$	
I _R	Reverse Current	50 100	200 1000	μΑ	$V_R = 1200 \text{ V } T_J = 25^{\circ}\text{C}$ $V_R = 1200 \text{ V } T_J = 150^{\circ}\text{C}$	
Q _c	Total Capacitive Charge	28		nC	$V_R = 1200 \text{ V, } I_F = 5 \text{ A}$ $di/dt = 500 \text{ A/}\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	
С	Total Capacitance	455 45 33		pF	$V_R = 0 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 200 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 400 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$	

Note:

Thermal Characteristics

Symbol	Parameter	Тур.	Unit
$R_{_{ heta JC}}$	Thermal Resistance from Junction to Case	1.1	°C/W

Typical Performance

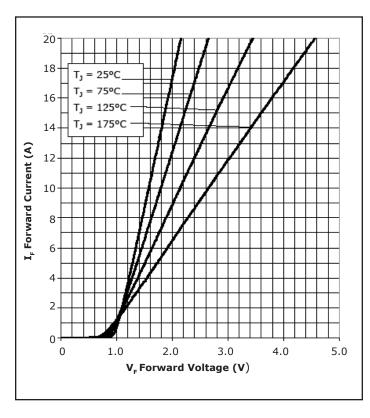


Figure 1. Forward Characteristics

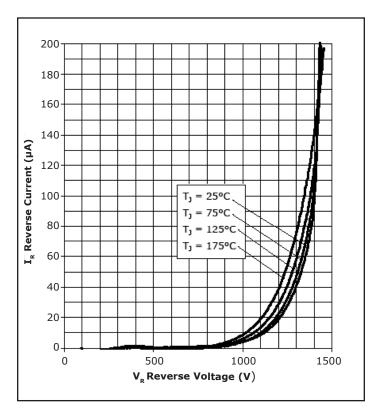


Figure 2. Reverse Characteristics

^{1.} This is a majority carrier diode, so there is no reverse recovery charge.



Typical Performance

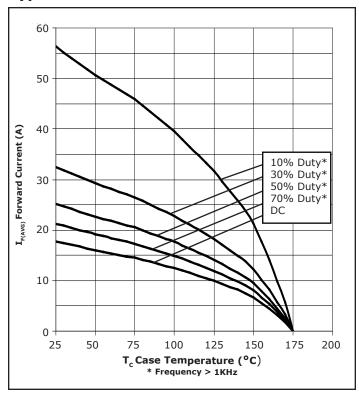


Figure 3. Current Derating

Figure 4. Capacitance vs. Reverse Voltage

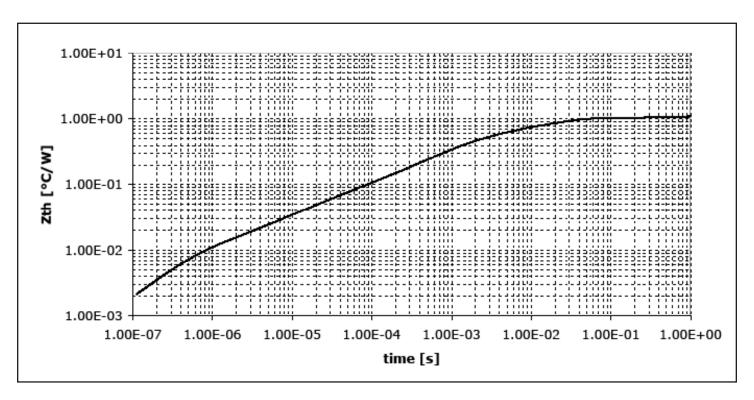
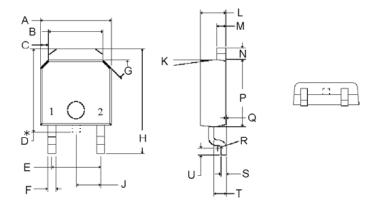


Figure 5. Transient Thermal Impedance



Package Dimensions

Package TO-252-2





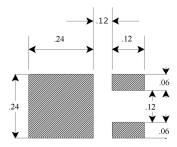
POS	Inc	hes	Millimeters		
PUS	Min	Max	Min	Max	
А	.250	.289	6.350	7.341	
В	.197	.215	5.004	5.461	
С	.027	.050	.686	1.270	
D*	.270	.322	6.858	8.179	
E	.178	.182	4.521	4.623	
F	.025	.045	.635	1.143	
G	44°	46°	44°	46°	
Н	.380	.410	9.652	10.414	
J	.090 TYP		2.286 TYP		
К	6°	8°	6°	8°	
L	.086	.094	2.184	2.388	
М	.018	.034	.457	.864	
N	.035	.050	.889	1.270	
Р	.231	.246	5.867	6.248	
Q	0.00	.005	0.00	.127	
R	R0.010 TYP		R0.25	4 TYP	
S	.017	.023	.432	.584	
Т	.038	.045	.965	1.143	
U	.021	.029	.533	.737	

Note:

^{*} Tab "D" may not be present



Recommended Solder Pad Layout



TO-252-2

**All dimensions in mils

Part Number	Package	Marking
C2D05120E	TO-252-2	C2D05120

"The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006."

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, air traffic control systems, or weapons systems.

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